Supplementary Information

Fast response ammonia sensors based on TiO_2 and NiO nanostructured bilayer thin films

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Figure S1. The cross-section micrographs of TiO_2/NiO bilayer sensor with different thickness of top TiO_2 layer

Figure S1 depicts the FE-SEM cross-sectional micrographs of four TiO_2/NiO bilayer sensing films. The results indicates that the bottom NiO film thickness was found to be fixed as 200 nm and the top TiO_2 film thickness was varied from 160 nm to 580 nm.



Figure S2. The cross-section micrographs of (a) pure TiO_2 of 400 nm and (b) pure NiO layer of 200 nm.

Figure S2 depicts the individual thickness of TiO_2 and NiO thin films to be nearly 400 nm and 200 nm respectively.



Figure S3. (a) Elemental mapping, and (b) EDS spectra of NiO/TiO₂ bilayer thin film.

Figure S3 shows the elemental mapping and EDS spectrum of NiO/TiO_2 bilayer sensor which indicate the uniform element distribution of titanium, oxygen and nickel elements. The red region of O, green region of Ti and yellow regions of Ni are typically overlapped.



Figure S4. Variation of the response of TiO_2/NiO sensor with thickness of top TiO_2 layer using different ammonia concentrations at 280°C.

Figure S4 shows that during the sensing measurements, the sensor response increases as the TiO_2 layer thickness increases from 160 nm to 400 nm but it decreases when the TiO_2 thickness further increases to 580 nm. It means the TiO_2/NiO bilayer sensor with 400 nm TiO_2 layer (at top) and 200 nm NiO layer (at bottom) exhibited the best sensing response towards ammonia at 280 °C.



Figure S5. (a) Stability test for 90 days and (b) Stable response up to 10^{th} cycles of TiO₂/NiO and NiO/TiO₂ bilayer sensors towards100 ppm NH₃ at 280°C and 200°C, respectively.

Figure S5 (a) and (b) shows the stability characteristics of TiO_2/NiO and NiO/TiO_2 bilayer sensors towards 100 ppm NH₃ at 280°C and 200°C respectively. During the measurements, the TiO_2/NiO and NiO/TiO_2 bilayer sensors exhibits nearly constant response signal (~10% changes) and (~12% changes) respectively, indicating the significant long term stability of the sensor. Therefore, we concluded that the above-mentioned stability test will contributes to establish both the bilayer sensors as potential candidate for NH₃ gas sensing application.



Figure S6. The cross-section micrographs of TiO_2/NiO bilayer sensor with Pt layer of 25 nm thick as bottom electrode.

Figure S6 shows the required FE-SEM cross section view of TiO_2/NiO bilayer with the Pt bottom contact (electrode) thickness of about 25 nm.



Figure S7. The schematic view of the TiO_2/NiO bilayer sensor with the platinum (Pt) as bottom and top electrodes

Figure S7 shows the schematic view of TiO_2/NiO bilayer sensor with the top and bottom Pt contacts (electrodes). For electrical measurements, the bottom contact layer and top dots of platinum (Pt) of 25 nm thickness were prepared using metal shadow mask on glass substrates via DC sputtering technique. The diameter of Pt dot is 0.5 mm and space between the two dots is 2 mm, approximately.

Sensor	Fabrication	NH ₃	Operating	Sensing	Response/	Ref.
(metal oxide)	technique	ppm	Temp.(°C)	response	recovery time	
Co ₃ O ₄ /SnO ₂	Hydrothermal	100	200	13.6	4 sec/	1
composite	route					
Pd/WO ₃	hydrothermal	1000	300	2.2	15 sec/76 sec	2
α -Fe ₂ O ₃	Sol-gel	100	RT	39%	27 sec/46 sec	3
NiO	Hydrothermal	30	RT	20%	29 sec/150 sec	4
nanoparticles	process					
TeO ₂ thin films	Sputtering	500	170	58%	3.1 min/5.6 min	5
Hierarchical	Thermal	300	200	6	16 sec/25 sec	6
SnO_2	evaporation					
Pd doped WO ₃	Screen	200	350	10		7
	printing					
ZnO	Hydrothermal	4.6	100	3.96%		8
1 11/0			20	<i>.</i>	1.2	0
h-WO ₃	Annealing	50	30	6	1.3 mm/3.8 mm	9
NiO-ZnO	Hydrothermal	50	RT	40%	27 sec/155 sec	10
	route					
TiO ₂ /NiO	DC sputtering	100	280	7.6	24 sec/45 sec	Present
bilayer thin film						work

Table S1: Brief summary of previous reported literature on several semiconductor oxide based

ammonia gas sensor prepared by various deposition techniques.

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